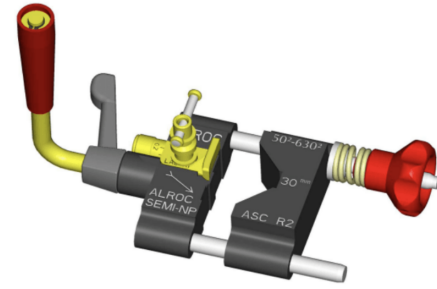




See online
technical sheet

/ ASC 25F

Tool for bonded semiconductor



/ Use

The ASC 25F is a tool that enables the user to shave the bonded semiconductor at the desired length with a chamfer.
Fixed penetration preset at 0.7mm.

/ Advantages

- Robust design
- Lightweight
- Easy to get to grips with

/ Technical specifications

- **Specific tools** : Cable tools
- **Cable tools** : Cable tools
- **For network cables** : HTA
- **Packaging** : Carton box
- **Lenght (mm)** : 195
- **Width (mm)** : 105
- **Height (mm)** : 130
- **Max diameter (mm)** : 44
- **Mini diameter (mm)** : 14
- **Incision depth on semi-peelable material** : 0,4 à 1 mm
- **Tools king** : Specific tools
- **Product universe** : Work
- **Penta marque** : PENTA ESP
- **Weight (g)** : 550